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# 1.425V to 3.6V Input, 2A, **0.2V Dropout LDO Regulators**

### **General Description**

The MAX8526/MAX8527/MAX8528 low-dropout linear regulators operate from input voltages as low as 1.425V and are able to deliver up to 2A of continuous output current with a maximum dropout voltage of only 200mV. The output voltage can be set from 0.5V to  $(V_{IN} - 0.2V)$ and is 1.4% accurate over load and line variations, from 0°C to +85°C.

These regulators use small, 2.2µF ceramic input capacitors and 10µF ceramic output capacitors to deliver 2A output current. High bandwidth provides excellent transient response and limits the output voltage deviation to 45mV for a 20mA to 2A load step, with only a 10µF ceramic output capacitor, and the voltage deviations can be reduced further by increasing the output capacitor.

Designed with an internal P-channel MOSFET pass transistor, the MAX8526/MAX8527/MAX8528 feature low 500µA typical supply current during dropout conditions. Soft-start reduces inrush current. Other features include a logic-controlled shutdown mode, short-circuit protection, and thermal-overload protection.

The MAX8527 features a power-OK (POK) output that transitions high when the regulator output is within ±10% of its nominal output voltage. The MAX8528 features a 150ms power-on reset (POR) output.

The parts are packaged in a 14-pin TSSOP package, which includes an exposed pad for optimal power dissipation.

### **Applications**

Servers

Networking

Storage

**Base Stations** 

**Optical Modules** 

Post Regulators

Notebooks

**PDAs** 

ATE

Pin Configurations appear at end of data sheet.

### **Features**

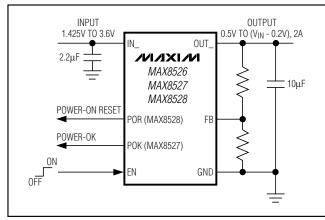
- ♦ 1.425V to 3.6V Input Voltage Range
- Guaranteed 200mV Dropout at 2A Output Current
- ♦ ±0.6% Initial Accuracy
- **♦** ±1.4% Output Accuracy over Load/Line/Temperature (0°C to +85°C)
- **♦** Compatible with Ceramic Capacitors
- **♦** Fast Transient Response
- ♦ 440µA Operating Supply Current
- ♦ <50µA Shutdown Supply Current</p>
- ♦ Short-Circuit Protection
- ♦ Thermal-Overload Protection
- ♦ Soft-Start Limits Inrush Current
- ♦ 5mm x 6.4mm Footprint, 1.1mm Profile

### **Ordering Information**

TEMP RANGE	PIN-PACKAGE
-40°C to +85°C	14 TSSOP
	-40°C to +85°C -40°C to +85°C -40°C to +85°C -40°C to +85°C -40°C to +85°C

<sup>+</sup>Denotes lead-free packaging.

# **Typical Operating Circuit**



#### **ABSOLUTE MAXIMUM RATINGS**

IN, EN, POK (MAX8527), POR (MAX8528 FB to GND OUT to GND Output Short-Circuit Duration (TA = +70° EP soldered to PC board ground) 14-Pin TSSOP (derate 20.8mW/°C abov	 Operating Temperature Range	+150°C 65°C to +150°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

(Circuit of Figure 1:  $V_{IN}$  = +1.8V,  $V_{OUT}$  = +1.5V, EN = IN,  $I_{OUT}$  = 2mA,  $T_A$  = -40°C to +85°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS		
IN							
Input Voltage Range		1.425		3.600	V		
Input Undervoltage Lockout	V <sub>IN</sub> rising, 70mV hysteresis	1.32	1.35	1.38	V		
OUT							
Output Voltage Range		0.5		3.4	V		
Load Regulation	I <sub>OUT</sub> = 2mA to 2A		0.08		%/A		
Line Regulation	$V_{IN} = 1.425V$ to 3.6V, $V_{OUT} = 1.225V$ , $I_{OUT} = 2mA$	-0.15	0	+0.15	%/V		
Dropout Voltage (VIN - VOUT)	$V_{IN} = 1.425V$ , $I_{OUT} = 2A$ , $V_{FB} = 480mV$		100	200	mV		
Current Limit	$V_{IN} = 3.6V$ , $V_{OUT} = 3V$ , $V_{FB} = 480$ mV	3.2	4	4.8	А		
Output Shutdown Leakage	V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 0, V <sub>EN</sub> = 0		0.5	50	μΑ		
FB							
	I <sub>OUT</sub> = 20mA, T <sub>A</sub> = +85°C	497	500	503			
FB Threshold Accuracy	$V_{OUT} = 1.225V$ to 3V, $V_{IN} = (V_{OUT} + 0.2V)$ to 3.6V, $I_{OUT} = 2mA$ to 2A	493		507	mV		
FB Input Bias Current	V <sub>FB</sub> = 0.5V, V <sub>IN</sub> = 3.6V		0.001	1	μΑ		

## **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1:  $V_{IN} = +1.8V$ ,  $V_{OUT} = +1.5V$ , EN = IN,  $I_{OUT} = 2mA$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted.) (Note 1)

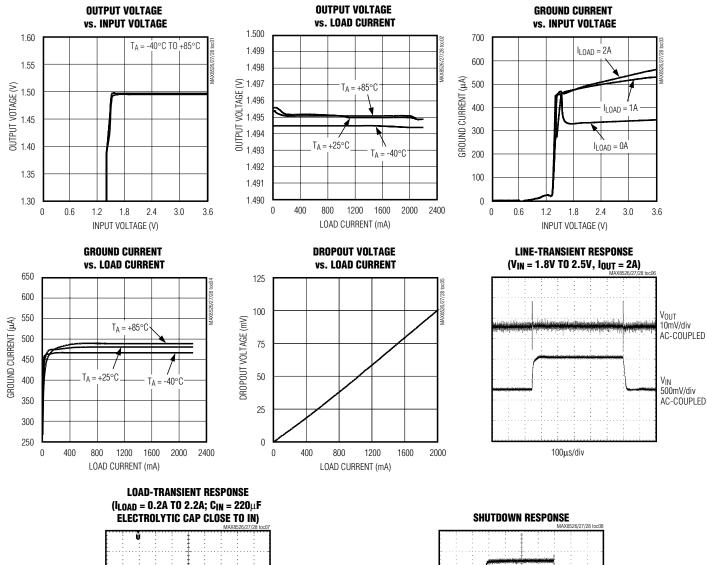
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS		
GND							
CND Complex Comment	V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 3V, I <sub>OUT</sub> = 20mA	V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 3V, I <sub>OUT</sub> = 20mA					
GND Supply Current	Dropout, $V_{IN} = 3.6V$ , $V_{FB} = 480$ mV			500	800	μΑ	
GND Shutdown Current	V <sub>IN</sub> = 3.6V, EN = GND			0.5	50	μΑ	
POK (MAX8527 only)							
Power-OK Threshold	V <sub>FB</sub> moving out of regulation,	FB high	540	550	560	mV	
Tower of Thiodian	$V_{HYS} = 10 \text{mV}, IN = 1.425 \text{V to } 3.6 \text{V}$	FB low	440	450	460	1114	
POK Output Voltage Low	$V_{FB} = 0.4V$ or 0.6V, $I_{POK} = 2mA$			25	200	mV	
POK Output Current High	$V_{POK} = 3.6V$			0.001	1	μΑ	
POK Fault Delay Time	From FB to POK		25	50	100	μs	
POR (MAX8528 only)							
Power-On Reset Threshold	V <sub>FB</sub> falling, V <sub>HYS</sub> = 10mV, V <sub>IN</sub> = 1.425	V to 3.6V	440	450	460	mV	
POR Output Voltage Low	$V_{FB} = 0.4V$ or 0.6V, $I_{POR} = 2mA$		25	200	mV		
POR Output Current High	$V_{POR} = 3.6V$		0.001	1	μΑ		
POR Rising Delay Time	From FB to POR 105			150	210	ms	
EN							
Enable Input Threshold	V <sub>IN</sub> = 1.425V to 3.6V	EN rising			1.2	- v	
Enable Input Threshold		EN falling	0.4				
Enable Input Bias Current	V <sub>EN</sub> = 0 or 3.6V	V <sub>EN</sub> = 0 or 3.6V			+1	μΑ	
THERMAL SHUTDOWN							
The amount of the state of the		T <sub>J</sub> rising		+165		°C	
Thermal-Shutdown Threshold	Output on or off	T <sub>J</sub> falling		+150			
OUTPUT TRANSIENT							
Load Transient	IOUT = 20mA to 2A to 20mA, tRISE = tp		3		%		
Line Transient	$\delta V_{IN} = 0.5 V$ , $t_{RISE} = t_{FALL} = 5 \mu s$			3		%	

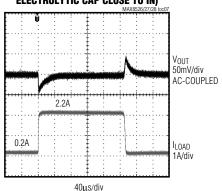
**Note 1:** Specifications to -40°C are guaranteed by design, not production tested.

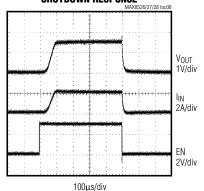
**Note 2:** Measurements at high current are pulse tested, such that the junction temperature is ambient temperature. Minimum supply voltage for output accuracy must be at least 1.425V.

### **Typical Operating Characteristics**

(Typical values are:  $V_{IN} = +1.8V$ ,  $V_{OUT} = +1.5V$ ,  $I_{OUT} = 2A$ ,  $C_{OUT} = 10\mu F$ ,  $C_{IN} = 2.2\mu F$ , and  $T_A = +25^{\circ}C$ , unless otherwise noted.)

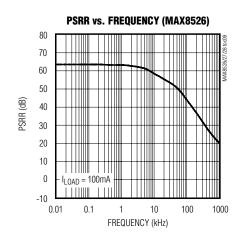


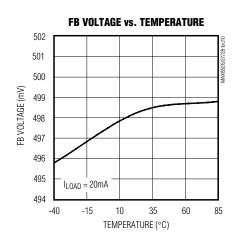


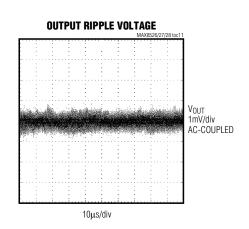


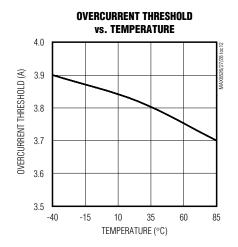
### Typical Operating Characteristics (continued)

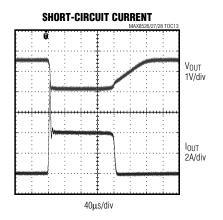
(Typical values are:  $V_{IN} = +1.8V$ ,  $V_{OUT} = +1.5V$ ,  $I_{OUT} = 2A$ ,  $C_{OUT} = 10\mu F$ ,  $C_{IN} = 2.2\mu F$ , and  $T_A = +25^{\circ}C$ , unless otherwise noted.)

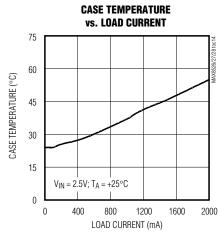








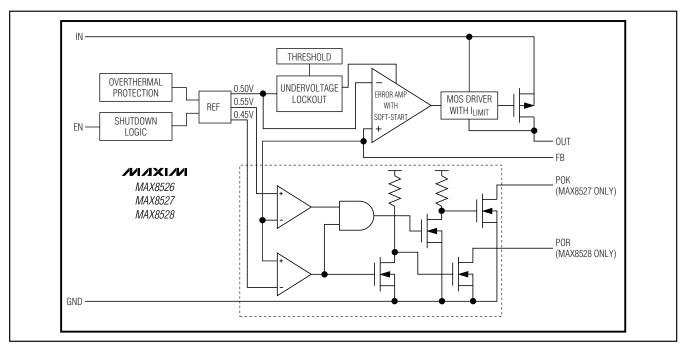




## **Pin Description**

PIN				
MAX8526	MAX8527	MAX8528	NAME	DESCRIPTION
1	1	1	EN	Enable Input. Set low to place the device in low-current shutdown mode. Set high for normal operation.
2–5	2–5	2–5	IN	Regulator Input. V <sub>IN</sub> can range from 1.425V to 3.6V. Bypass with a 2.2µF or higher ceramic capacitor to GND.
6, 7, 14	7, 14	6, 14	T.P.	Test Pin
8	8	8	GND	Ground
9	9	9	FB	Feedback Pin. Connect to output through a voltage-divider to set the output.
10–13	10–13	10–13	OUT	Regulator Output. Bypass with a 10 $\mu$ F ceramic capacitor to GND (a smaller capacitor can be used if maximum load is less than 2A, i.e., $C_{OUT} = I_{OUT}$ (max) x (1 $\mu$ F/200mA).
_	6	_	POK	Power-OK Output (MAX8527 Only). Open-drain output. Connect to a positive supply with a pullup resistor. If not used, leave pin unconnected. See the <i>Detailed Description</i> for more details.
_	_	7	POR	Power-On Reset Output. Open-drain output. Connect to a positive supply with a pullup resistor. If not used, leave pin unconnected. See the <i>Detailed Description</i> for more details.
	Exposed Pad		_	Exposed Pad on the Underside of the Package. Solder to the ground plane for proper heat dissipation.

# Functional Diagram



### **Detailed Description**

The MAX8526/MAX8527/MAX8528 are low-input, low-dropout, PMOS regulators capable of delivering up to 2A of output current with as little as 200mV of headroom from input to output. The PMOS output stage can be driven from input voltages down to +1.425V without sacrificing stability or transient performance. Since this regulator has a PMOS output device, supply current is not a significant function of load or input headroom.

#### **Internal P-Channel Pass Transistor**

The MAX8526/MAX8527/MAX8528 feature a  $50m\Omega$  (typ) P-channel MOSFET pass transistor. Unlike similar designs using PNP pass transistors, P-channel MOSFETs require no base drive, which reduces quiescent current. PNP-based regulators also waste considerable current in dropout when the pass transistor saturates, and use high base-drive currents under large loads. The MAX8526/MAX8527/MAX8528 do not suffer from these problems and consume only  $500\mu A$  (typ) of quiescent current under heavy loads, as well as in dropout.

### **Short-Circuit/Thermal Fault Protection**

The MAX8526/MAX8527/MAX8528 are fully protected from a short circuit at the output through current-limiting and thermal-overload circuitry. In the fault condition when the output is shorted to ground, the output current is limited to 4A. Under these conditions, the part quickly heats up. When the junction temperature reaches +165°C, the thermal-overload circuitry turns off the output, allowing the part to cool down. When the junction temperature cools to +150°C, the output turns back on and tries to reestablish regulation. Current limiting and thermal protection continue until the fault is removed. For continuous operation, do not exceed the absolute maximum junction temperature rating of  $T_{\rm J}$  = +150°C.

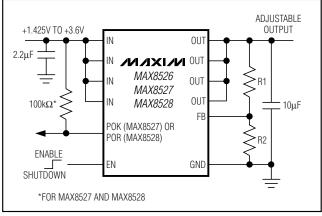


Figure 1. Typical Application Circuit

#### **Output Voltage Selection**

The MAX8526/MAX8527/MAX8528 feature an adjustable output voltage from 0.5V to 3.4V, using two external resistors connected as a voltage-divider to FB as shown in Figure 1. The output voltage is set by the following equation:

$$V_{OUT} = V_{FB} \left( 1 + \frac{R1}{R2} \right)$$

where typically VFB = 0.5V. Choose R2  $\leq$  5k $\Omega$  to optimize quiescent current, accuracy, and high-frequency power-supply rejection. To simplify resistor selection:

$$R1 = R2 \left( \frac{V_{OUT}}{V_{FB}} - 1 \right)$$

#### Soft-Start

Inherent soft-start limits inrush current. Peak inrush current is dependent on the value of  $C_{\text{OUT}}$  and can be calculated as follows:

$$I_{INRUSH} = I_{LOAD} + \left(\frac{C_{OUT}(\mu F)}{66}\right)$$

#### Shutdown Mode

The MAX8526/MAX8527/MAX8528 include an enable input. To shut down the device, pull EN to GND. For normal operation, connect the EN to IN. During shutdown, an internal  $10k\Omega$  resistor pulls down the output.

#### Power-OK (POK, MAX8527 Only)

The MAX8527 features a power-OK output to indicate the status of the output. POK remains high when the regulator output is within ±10% of its nominal output voltage. If the output voltage falls/rises outside this range, POK transitions low. This open-drain output requires an external pullup resistor to IN. An internal delay circuit prevents the POK from switching for 50µs (typ) after the trip threshold is initially reached. If the part is in shutdown mode, POK is low.

### Power-On Reset (POR, MAX8528 Only)

The MAX8528 features a power-on reset output that transitions high 150ms (typ) after the output has risen above 90% of its final value. This open-drain output requires an external pullup resistor to IN. If the part is in shutdown mode, falls below 90% of the nominal output voltage, or experiences a short-circuit/thermal fault, POR immediately transitions low.

#### **Operating Region and Power Dissipation**

The maximum power dissipation depends on the thermal resistance of the IC package and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The power dissipated in the device is  $P = I_{QUT} \times (V_{IN} - V_{QUT})$ .

The package features an exposed thermal pad on its underside. This pad lowers the thermal resistance of the package by providing a direct heat conduction path from the die to the PC board.

Additionally, the ground pins (GND) perform the dual function of providing an electrical connection to system ground and channeling heat away. Connect the exposed backside pad and GND to the system ground using a large pad or ground plane, or multiple vias to the ground-plane layer.

### **Applications Information**

# Capacitor Selection and Regulator Stability

Capacitors are required at the MAX8526/MAX8527/MAX8528 inputs and outputs for stable operation over the full temperature range and with load currents up to 2A. Connect a 2.2µF capacitor between IN and ground and a 10µF capacitor with low equivalent-series-resistance (ESR) capacitor between OUT and ground for 2A

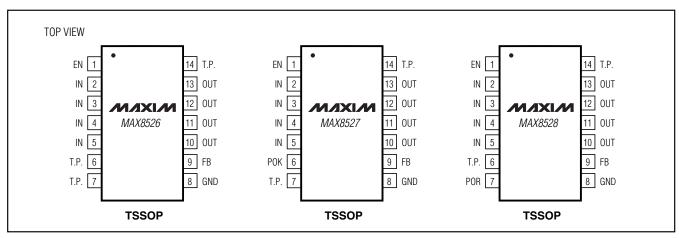
output current. The input capacitor ( $C_{IN}$ ) lowers the source impedance of the input supply. If input-supply source impedance is high, place a larger input capacitor close to IN to prevent  $V_{IN}$  sagging due to load transients. Smaller output capacitors can be used for output currents less than 2A. Calculate  $C_{OUT}$  as follows:

 $C_{OUT} = I_{OUT(max)} \times (1 \mu F / 200 mA)$ 

### Noise, PSRR, and Transient Response

The MAX8526/MAX8527/MAX8528 are designed to operate with low dropout voltages and low guiescent currents, while still maintaining good noise, transient response, and AC rejection. See the Typical Operating Characteristics for a plot of Power-Supply Rejection Ratio (PSRR) vs. Frequency. When operating from noisy sources, improved supply-noise rejection and transient response can be achieved by increasing the values of the input and output bypass capacitors and through passive filtering techniques. The MAX8526/ MAX8527/MAX8528 load-transient response graphs (see the Typical Operating Characteristics) show two components of the output response: a DC shift from the output impedance due to the load current change, and the transient response. A typical transient overshoot for a step change in the load current from 20mA to 2A is 45mV. Use larger output ceramic capacitors greater than 10µF up to 100µF to attenuate the overshoot.

# Pin Configurations



**Chip Information** 

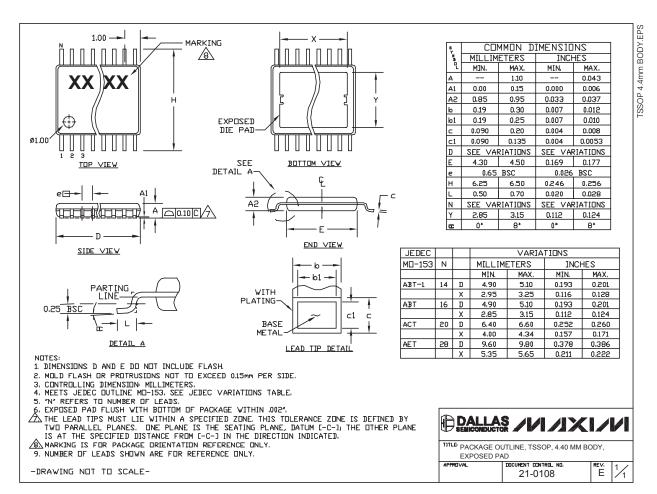
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PROCESS: BICMOS

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### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



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